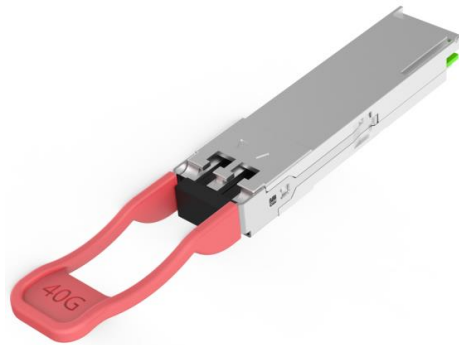


40Gb/s QSFP+ 40km Transceiver HXQX-QLC41x

Features

- Up to 11.2Gb/s data rate per channel
- 4 CWDM lanes MUX/DEMUX
- Up to 40km transmission
- SMF LC duplex connector
- QSFP+ MSA compliant
- Electrically hot-pluggable
- Optical link budget: 16dBm
- RoHS-6 compliant and lead-free
- Support Digital Monitoring interface
- Single +3.3V power supply
- Maximum power consumption 3.5W
- All-metal housing for superior EMI performance
- Case operating temperature
Commercial: 0 ~ +70°C
Extended: -10 ~ +80°C
Industrial: -40 ~ +85°C



Applications

- 40G Ethernet
- Data Center
- Back to Back
- InfiniBand QDR

Part Number Ordering Information

| Part Number | Data Rate (Gb/s) | Wavelength (nm) | Transmission Distance(km) | Temperature (°C) (Operating Case) |
|-------------|------------------|-------------------------|---------------------------|-----------------------------------|
| HXQX-QLC41C | 40 | 1271/1291/ 1311/1331 | 40 | 0~70 commercial |
| HXQX-QLC41E | 40 | | 40 | -10~80 Extended |
| HXQX-QLC41I | 40 | | 40 | -40~85 Industrial |

I. Absolute Maximum Ratings

It has to be noted that the operation in excess of any individual absolute maximum ratings might cause permanent damage to this module.

| Parameter | Symbol | Min | Max | Unit | Notes |
|--------------------------------------|-----------------|-----|------|------|-------|
| Storage Temperature | T _S | -40 | 85 | °C | |
| Power Supply Voltage | V _{CC} | 0 | 3.47 | V | |
| Relative Humidity (non-condensation) | RH | 5 | 95 | % | |
| Damage Threshold | TH _d | 0 | | dBm | |

II. Recommended Operating Conditions

| Parameter | Symbol | Min | Typical | Max | Unit | Notes |
|----------------------------|-----------------|-------|---------|-----------------|------|------------|
| Operating Case Temperature | T _{OP} | 0 | | 70 | °C | commercial |
| | | -40 | | 85 | °C | Industrial |
| Power Supply Voltage | V _{CC} | 3.135 | 3.3 | 3.465 | V | |
| Data Rate | | | 40 | | Gb/s | |
| Control Input Voltage High | | 2 | | V _{cc} | V | |
| Control Input Voltage Low | | 0 | | 0.8 | V | |
| Link Distance (SMF) | D | | | 40 | km | 9/125um |

III. General Description

Walsun'HXQX-QLC41C is a parallel 40Gb/s Quad Small Form-factor Pluggable (QSFP+) optical module and designed for 40km optical communication applications. The module converts 4 inputs channels (ch) of 10Gb/s electrical data to 4 CWDM optical signals, and multiplexes them into a single channel for 40Gb/s optical transmission. Reversely, on the receiver side, the module optically de-multiplexes a 40Gb/s input into 4 CWDM channels signals, and converts them to 4 channel output electrical data.

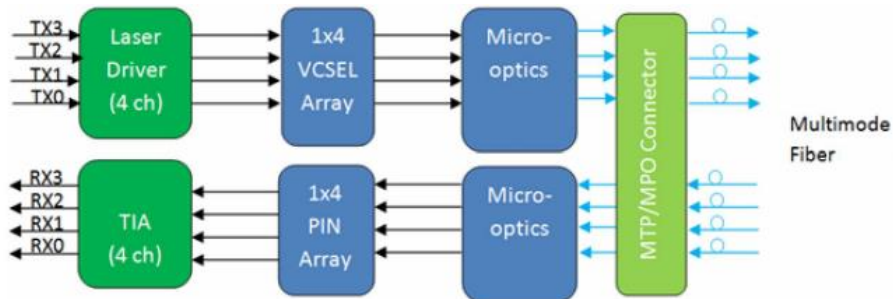
The central wavelengths of the 4 CWDM channels are 1271, 1291, 1311 and 1331 nm as members of the CWDM wavelength grid defined in ITU-T G694.2. It contains a duplex LC connector for the optical interface and a 38-pin connector for the electrical interface. To minimize the optical dispersion in the long-haul system, single-mode fiber (SMF) has to be applied in this module.

The module operates by a single +3.3V power supply. LVCMOS/LVTTL global control signals, such as Module Present, Reset, Interrupt and Low Power Mode, are available with the modules. A 2-wire serial interface is available to send and receive more complex control signals, and to receive digital diagnostic information. Individual channels can be addressed and unused channels can be shut down for maximum design flexibility.

The product is designed with form factor, optical/electrical connection and digital diagnostic interface according to the QSFP+ Multi-Source Agreement (MSA). It has been designed to meet

the harshest external operating conditions including temperature, humidity and EMI interference. The module offers very high functionality and feature integration, accessible via a two-wire serial interface.

IV. Transceiver Block Diagram



V. Pin Assignment and Pin Description

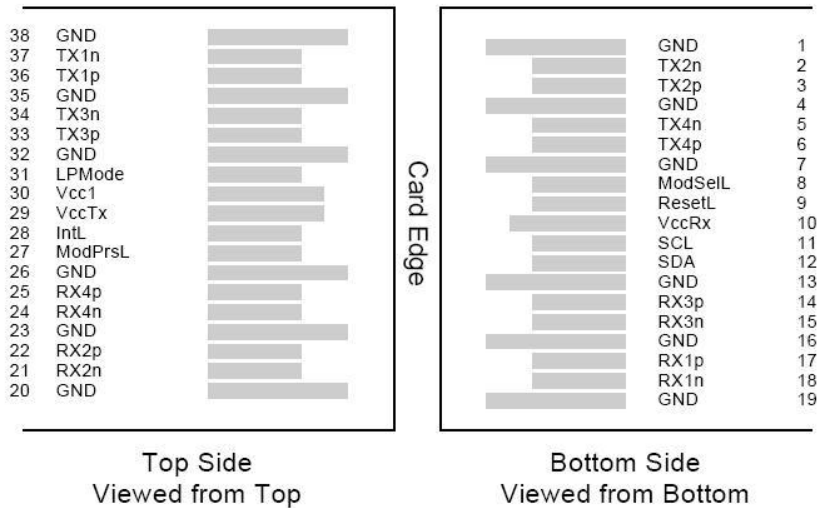


Figure1. QSFP+ Transceiver Electrical Pad Layout

| PIN | Logic | Symbol | Name/Description | Notes |
|-----|-------|--------|--------------------------------------|-------|
| 1 | | GND | Ground | 1 |
| 2 | CML-I | Tx2n | Transmitter Inverted Data Input | |
| 3 | CML-I | Tx2p | Transmitter Non-Inverted Data output | |
| 4 | | GND | Ground | 1 |
| 5 | CML-I | Tx4n | Transmitter Inverted Data Input | |
| 6 | CML-I | Tx4p | Transmitter Non-Inverted Data output | |
| 7 | | GND | Ground | 1 |

| | | | | |
|----|-------------|---------|-------------------------------------|---|
| 8 | LVTLL-I | ModSelL | Module Select | 3 |
| 9 | LVTLL-I | ResetL | Module Reset | 4 |
| 10 | | VccRx | +3.3V Power Supply Receiver | 2 |
| 11 | LVC MOS-I/O | SCL | 2-Wire Serial Interface Clock | 5 |
| 12 | LVC MOS-I/O | SDA | 2-Wire Serial Interface Data | 5 |
| 13 | | GND | Ground | |
| 14 | CML-O | Rx3p | Receiver Non-Inverted Data Output | |
| 15 | CML-O | Rx3n | Receiver Inverted Data Output | |
| 16 | | GND | Ground | 1 |
| 17 | CML-O | Rx1p | Receiver Non-Inverted Data Output | |
| 18 | CML-O | Rx1n | Receiver Inverted Data Output | |
| 19 | | GND | Ground | 1 |
| 20 | | GND | Ground | 1 |
| 21 | CML-O | Rx2n | Receiver Inverted Data Output | |
| 22 | CML-O | Rx2p | Receiver Non-Inverted Data Output | |
| 23 | | GND | Ground | 1 |
| 24 | CML-O | Rx4n | Receiver Inverted Data Output | 1 |
| 25 | CML-O | Rx4p | Receiver Non-Inverted Data Output | |
| 26 | | GND | Ground | 1 |
| 27 | LVTTL-O | ModPrsL | Module Present | 6 |
| 28 | LVTTL-O | IntL | Interrupt | 7 |
| 29 | | VccTx | +3.3 V Power Supply transmitter | 2 |
| 30 | | Vcc1 | +3.3 V Power Supply | 2 |
| 31 | LVTTL-I | LPMode | Low Power Mode | 8 |
| 32 | | GND | Ground | 1 |
| 33 | CML-I | Tx3p | Transmitter Non-Inverted Data Input | |
| 34 | CML-I | Tx3n | Transmitter Inverted Data Output | |
| 35 | | GND | Ground | 1 |
| 36 | CML-I | Tx1p | Transmitter Non-Inverted Data Input | |

| | | | | |
|----|-------|------|----------------------------------|---|
| 37 | CML-I | TxIn | Transmitter Inverted Data Output | |
| 38 | | GND | Ground | 1 |

Notes:

1. GND is the symbol for signal and supply (power) common for QSFP+ modules. All are common within the QSFP+ module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
2. VccRx, Vcc1 and VccTx are the receiver and transmitter power suppliers and shall be applied concurrently. Recommended host board power supply filtering is shown in Figure 4 below. Vcc Rx, Vcc1 and Vcc Tx may be internally connected within the QSFP+ transceiver module in any combination. The connector pins are each rated for a maximum current of 500mA.
3. Module Select (ModSelL) is an input pin. When held low by the host, the module responds to 2-wire serial communication commands. The ModSelL allows the use of multiple QSFP+ modules on a single 2-wire interface bus – individual ModSelL lines for each QSFP+ module must be used.
4. The ResetL pin enables a complete module reset, returning module settings to their default state, when a low level on the ResetL pin is held for longer than the minimum pulse length. During the execution of a reset the host shall disregard all status bits until the module indicates a completion of the reset interrupt. The module indicates this by posting an IntL (Interrupt) signal with the Data_Not_Ready bit negated in the memory map. Note that on power up (including hot insertion) the module should post this completion of reset interrupt without requiring a reset.
5. Serial Clock (SCL) and Serial Data (SDA) are required for the 2-wire serial bus communication interface and enable the host to access the QSFP+ memory map.
6. Module Present (ModPrsL) is a signal local to the host board which, in the absence of a module, is normally pulled up to the host Vcc. When a module is inserted into the connector, it completes the path to ground through a resistor on the host board and asserts the signal. ModPrsL then indicates a module is present by setting ModPrsL to a “Low” state.
7. Interrupt (IntL) is an output pin. Low indicates a possible module operational fault or a status critical to the host system. The host identifies the source of the interrupt using the 2-wire serial interface. The IntL pin is an open collector output and must be pulled to the Host Vcc voltage on the Host board
8. Low Power Mode (LPMODE) pin is used to set the maximum power consumption for the module in order to protect hosts that are not capable of cooling higher power modules, should such modules be accidentally inserted.

VI. Electrical Characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

| Parameter | Symbol | Min. | Typ. | Max | Unit | Notes |
|-------------------|--------|------|------|-----|------|-------|
| Power Consumption | p | | | 3.5 | W | |
| Supply Current | Icc | | | 900 | mA | |

| Transmitter | | | | | | |
|--------------------------------------|---------|---------|-----|----------|----------|--|
| Single-ended Input Voltage Tolerance | Vcc | -0.3 | | 4.0 | V | |
| Differential Input Voltage Swing | Vin,pp | 190 | | 700 | mVp p | |
| Differential Input Impedance | Zin | 90 | 100 | 110 | Ohm | |
| Transmit Disable Assert Time | | | | 10 | us | |
| Transmit Disable Voltage | Vdis | Vcc-1.3 | | Vcc | V | |
| Transmit Enable Voltage | Ven | Vee | | Vee +0.8 | V | |
| Receiver | | | | | | |
| Single-ended Input Voltage Tolerance | Vcc | -0.3 | | 4.0 | V | |
| Differential Output Voltage Swing | Vout,pp | 300 | | 850 | mVp p | |
| Differential Output Impedance | Zout | 90 | 100 | 110 | Ohm | |
| J9 Jitter Output | Jo9 | | | 0.65 | UI | |
| LOS Assert Voltage | VlosH | Vcc-1.3 | | Vcc | V | |
| LOS De-assert Voltage | VlosL | Vee | | Vee +0.8 | V | |

VII. Optical Characteristics

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

| Parameter | Symbol | Min. | Typical | Max | Unit | Notes |
|-------------------------|--------|--------|---------|--------|------|-------|
| Transmitter | | | | | | |
| Lane wavelength (range) | L0 | 1264.5 | 1271 | 1277.5 | nm | |
| | L1 | 1284.5 | 1291 | 1297.5 | nm | |
| | L2 | 1304.5 | 1311 | 1317.5 | nm | |
| | L3 | 1324.5 | 1331 | 1337.5 | nm | |

| | | | | | | |
|--|----------------|------------------------------------|------|-----|-----|---|
| Spectral Band Width | λ | | | 1 | nm | |
| Signaling rate, each lane | | | 11.2 | | GBd | |
| Side-mode suppression ratio | SMSR | 30 | | | | |
| Total launch power | | | | 8.3 | dBm | 1 |
| Average launch power, each lane | P_{avg} | -2.7 | | 4.5 | dBm | |
| Extinction Ratio | ER | 3.5 | | | dB | |
| Transmitter and Dispersion Penalty, each lane | TDP | | | 2.3 | dB | |
| OMA minus TDP, each lane | OMA-TDP | -2.3 | | | dBm | |
| Average launch power of OFF transmitter, each lane | | P_{off} | | -30 | dBm | |
| Transmitter reflectance | | | | -12 | dB | |
| Transmitter eye mask {X1, X2,X3, Y1, Y2, Y3} | | {0.25, 0.4, 0.45, 0.25, 0.28, 0.4} | | | | |
| Receiver | | | | | | |
| Signaling rate, each lane | | | 11.2 | | GBd | |
| Receiver Sensitivity (Average Power), each Lane | Sen. | | | -19 | dBm | 2 |
| Input Saturation Power (Overload) | P_{sat} | 3.3 | | | dBm | |
| Receiver reflectance | R_r | | | -26 | dB | |
| LOS Assert | P_{los_on} | -35 | | | dBm | |
| LOS De-assert | P_{los_off} | | | -23 | | |
| LOS Hysteresis | | 0.5 | | 4 | dB | |

Notes:

1. Class 1 Laser Safety per FDA/CDRH and IEC-825-1 regulations.
2. Measured with Light source 1271/1291/1311/1311nm, ER=3.5dB; BER \leq 1E-12 @40Gbps, PRBS=2³¹ -1 NRZ.

VIII. Digital Diagnostic Functions

The following digital diagnostic characteristics are defined over the Recommended Operating Environment unless otherwise specified.

| Parameter | Symbol | Min. | Max | Unit | Notes |
|---------------------------------------|----------|-------|------|------|----------------------|
| Temperature monitor absolute error | DMI_Temp | -3 | 3 | °C | Over operating temp |
| Supply voltage monitor absolute error | DMI_VCC | -0.15 | 0.15 | V | Full operating range |
| RX power monitor absolute error | DMI_RX | -3 | 3 | dB | |
| Bias current monitor | DMI_bias | -10% | 10% | mA | |
| TX power monitor absolute error | DMI_TX | -3 | 3 | dB | |

IX. Mechanical Dimensions

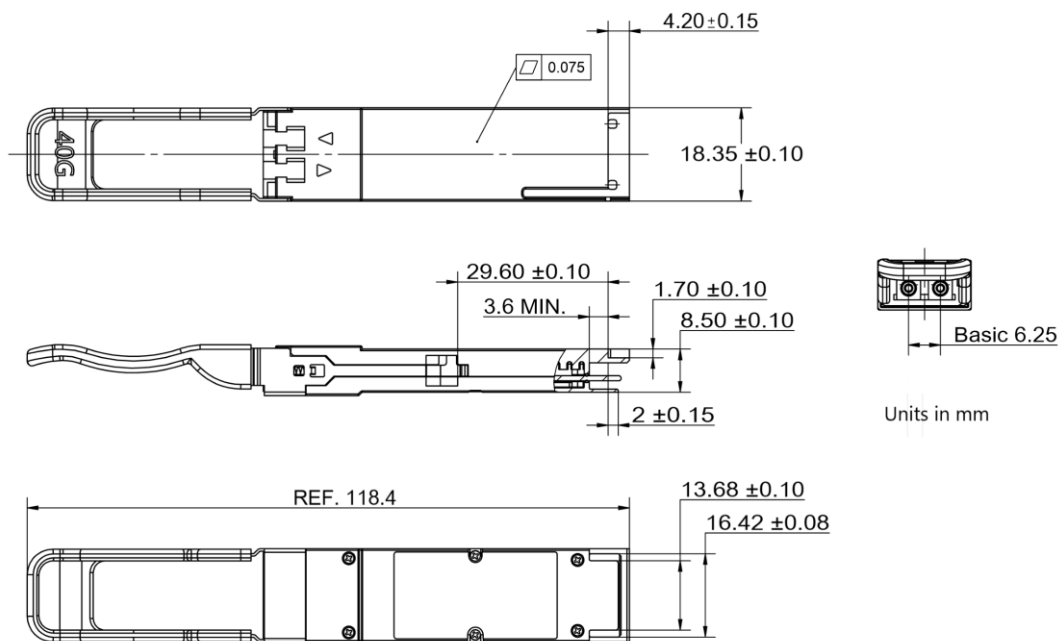


Figure2. Mechanical Outline

X. Revision History

| Version No. | Initiated | Revised contents | Release Date |
|-------------|------------|-----------------------|--------------|
| V1.0 | Andy Zhang | Preliminary datasheet | 2018-09-20 |
| | | | |

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